

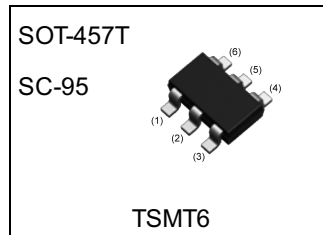
<For Tr1(NPN)>

Parameter	Value
V_{CEO}	50V
I_C	1A

<For Tr2(PNP)>

Parameter	Value
V_{CEO}	-50V
I_C	-1A

● Outline



● Features

1) Low saturation voltage.

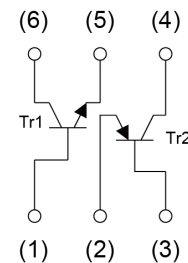
$$V_{CE(sat)} = 350\text{mV (Max.)} (I_C/I_B) = 500\text{mA}/25\text{mA}$$

$$V_{CE(sat)} = -400\text{mV (Max.)} (I_C/I_B) = -500\text{mA}/-25\text{mA}$$

2) High speed switching

● Inner circuit

- (1) Tr1(NPN) Base
- (2) Tr2(PNP) Emitter
- (3) Tr2(PNP) Base
- (4) Tr2(PNP) Collector
- (5) Tr1(NPN) Emitter
- (6) Tr1(NPN) Collector



● Application

Low frequency amplifier, High speed switching

● Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Quantity (pcs)	Marking
QS6Z5	SOT-457T (TSMT6)	2928	TR	180	8	3000	Z05

● Absolute maximum ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Tr1(NPN)	Tr2(PNP)	Unit
Collector-base voltage	V_{CBO}	50	-50	V
Collector-emitter voltage	V_{CEO}	50	-50	V
Emitter-base voltage	V_{EBO}	6	-6	V
Collector current	I_C	1	-1	A
	I_{CP}^{*1}	2	-2	A
Power dissipation	P_D^{*2}	0.5		W/Total
	P_D^{*3*4}	1.25		W/Total
Junction temperature	T_j	150		$^\circ\text{C}$
Range of storage temperature	T_{stg}	-55 to +150		$^\circ\text{C}$

● **Electrical characteristics** ($T_a = 25^\circ\text{C}$) <For Tr1(NPN)>

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Collector-base breakdown voltage	BV_{CBO}	$I_C = 100\mu\text{A}$	50	-	-	V
Collector-emitter breakdown voltage	BV_{CEO}	$I_C = 1\text{mA}$	50	-	-	V
Emitter-base breakdown voltage	BV_{EBO}	$I_E = 100\mu\text{A}$	6	-	-	V
Collector cut-off current	I_{CBO}	$V_{CB} = 50\text{V}$	-	-	1.0	μA
Emitter cut-off current	I_{EBO}	$V_{EB} = 4\text{V}$	-	-	1.0	μA
Collector-emitter saturation voltage	$V_{CE(sat)}^{*5}$	$I_C = 500\text{mA}, I_B = 25\text{mA}$	-	130	350	mV
DC current gain	h_{FE}	$V_{CE} = 2\text{V}, I_C = 50\text{mA}$	180	-	450	-
Transition frequency	f_T^{*5}	$V_{CE} = 10\text{V}, I_E = -200\text{mA}, f = 100\text{MHz}$	-	360	-	MHz
Output capacitance	C_{ob}	$V_{CB} = 10\text{V}, I_E = 0\text{A}, f = 1\text{MHz}$	-	7	-	pF
Turn-On time	t_{on}	$I_C = 500\text{mA}, V_{CC} \approx 10\text{V},$	-	40	-	ns
Storage time	t_{stg}	$I_{B1} = 50\text{mA}, I_{B2} = -50\text{mA},$	-	410	-	ns
Fall time	t_f	(See test circuit)	-	75	-	ns

● **Electrical characteristics** ($T_a = 25^\circ\text{C}$) <For Tr2(PNP)>

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Collector-base breakdown voltage	BV_{CBO}	$I_C = -100\mu\text{A}$	-50	-	-	V
Collector-emitter breakdown voltage	BV_{CEO}	$I_C = -1\text{mA}$	-50	-	-	V
Emitter-base breakdown voltage	BV_{EBO}	$I_E = -100\mu\text{A}$	-6	-	-	V
Collector cut-off current	I_{CBO}	$V_{CB} = -50\text{V}$	-	-	-1.0	μA
Emitter cut-off current	I_{EBO}	$V_{EB} = -4\text{V}$	-	-	-1.0	μA
Collector-emitter saturation voltage	$V_{CE(sat)}^{*5}$	$I_C = -500\text{mA}, I_B = -25\text{mA}$	-	-200	-400	mV
DC current gain	h_{FE}	$V_{CE} = -2\text{V}, I_C = -50\text{mA}$	180	-	450	-
Transition frequency	f_T^{*5}	$V_{CE} = -10\text{V}, I_E = 200\text{mA}, f = 100\text{MHz}$	-	400	-	MHz
Output capacitance	C_{ob}	$V_{CB} = -10\text{V}, I_E = 0\text{A}, f = 1\text{MHz}$	-	12	-	pF
Turn-On time	t_{on}	$I_C = -500\text{mA}, V_{CC} \approx -10\text{V}$	-	40	-	ns
Storage time	t_{stg}	$I_{B1} = -50\text{mA}, I_{B2} = 50\text{mA}$	-	250	-	ns
Fall time	t_f	(See test circuit)	-	35	-	ns

*1 $P_w = 10\text{ms}$ Single Pulse

*2 Each terminal mounted on a reference land.

*3 Mounted on a $25\text{mm} \times 25\text{mm} \times 0.8\text{mm}$ ceramic board.

*4 0.9W per element must not be exceeded.

*5 Pulsed

● Electrical characteristic curves ($T_a=25^\circ\text{C}$) <For Tr1(NPN)>

Fig.1 Ground emitter propagation characteristics

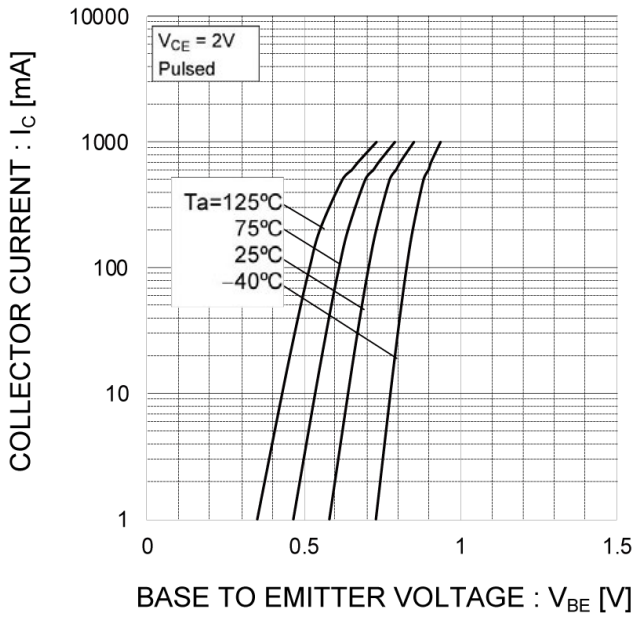


Fig.2 Typical output characteristics

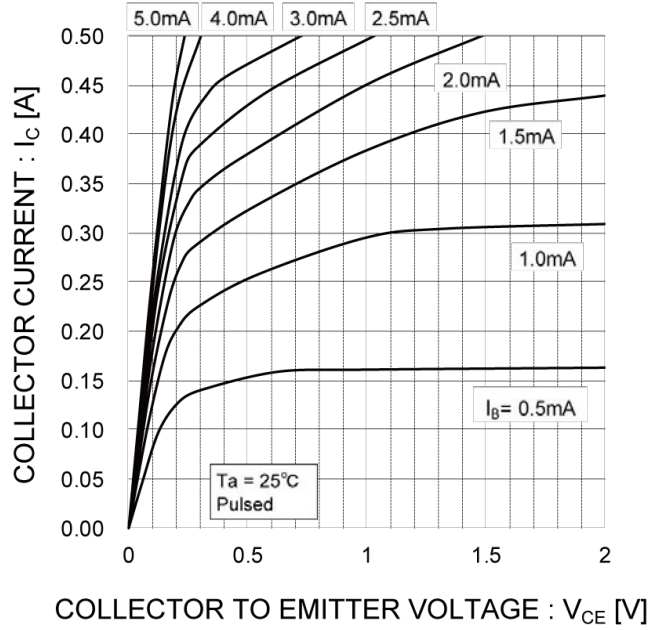


Fig.3 DC current gain vs. collector current (I)

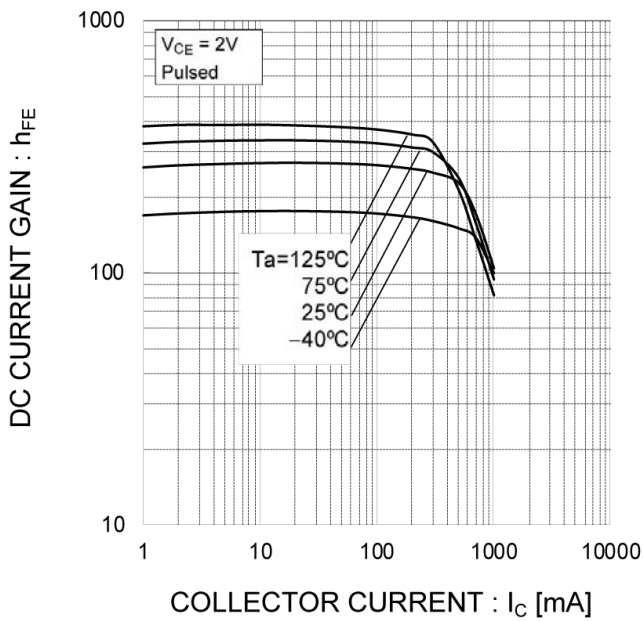
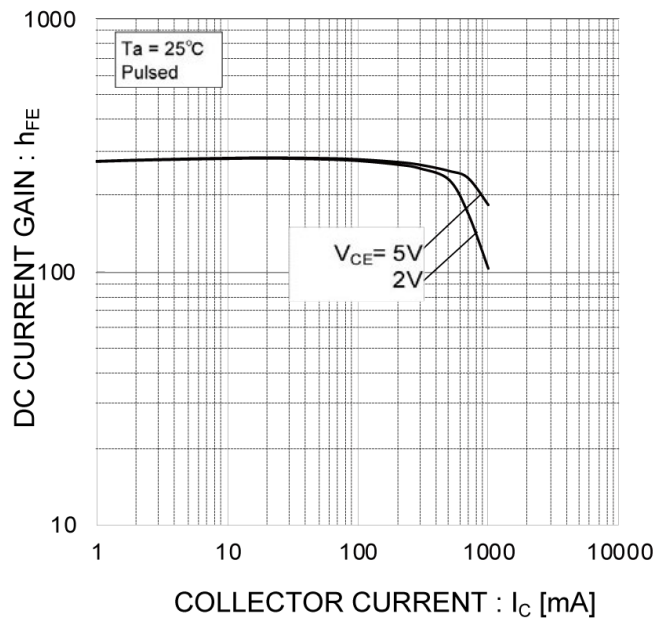


Fig.4 DC current gain vs. collector current (II)



● Electrical characteristic curves ($T_a=25^\circ\text{C}$) <For Tr1(NPN)>

Fig.5 Collector-emitter saturation voltage vs. collector current (I)

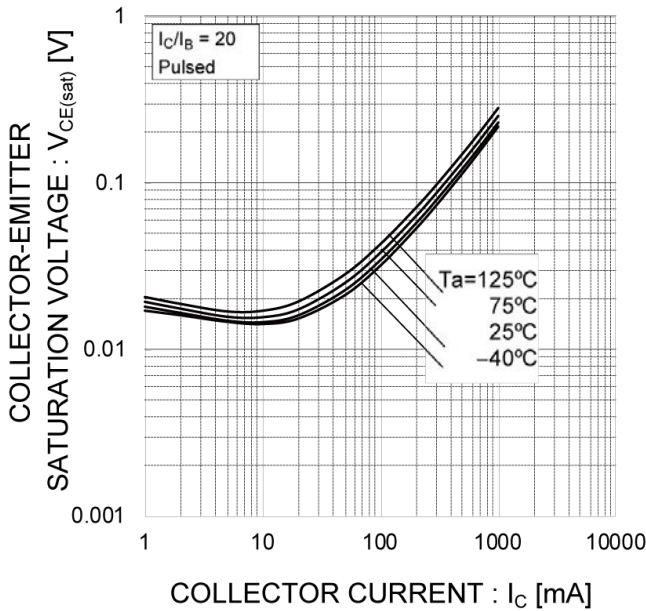


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

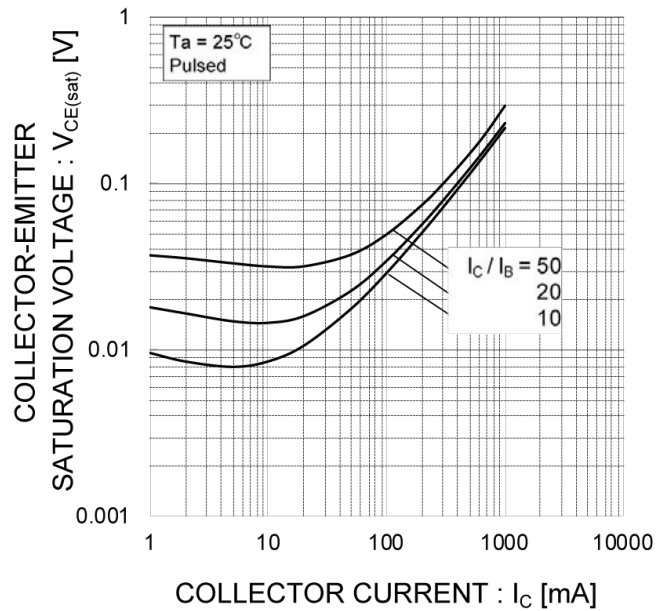


Fig.7 Base-emitter saturation voltage vs. collector current

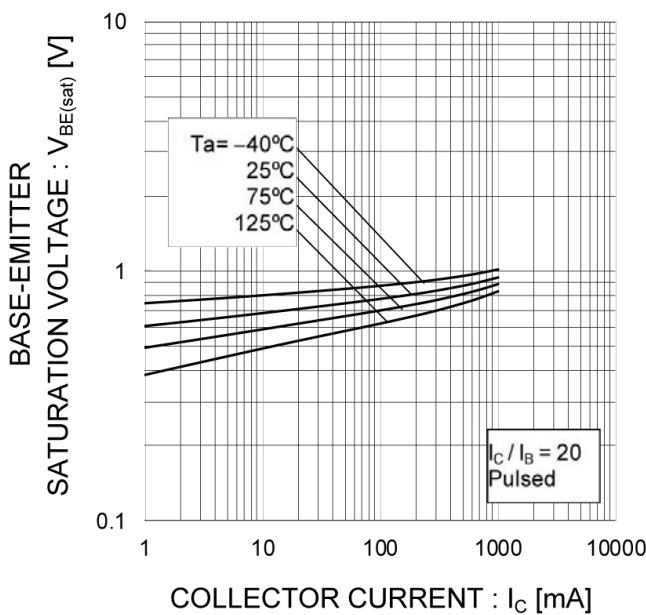
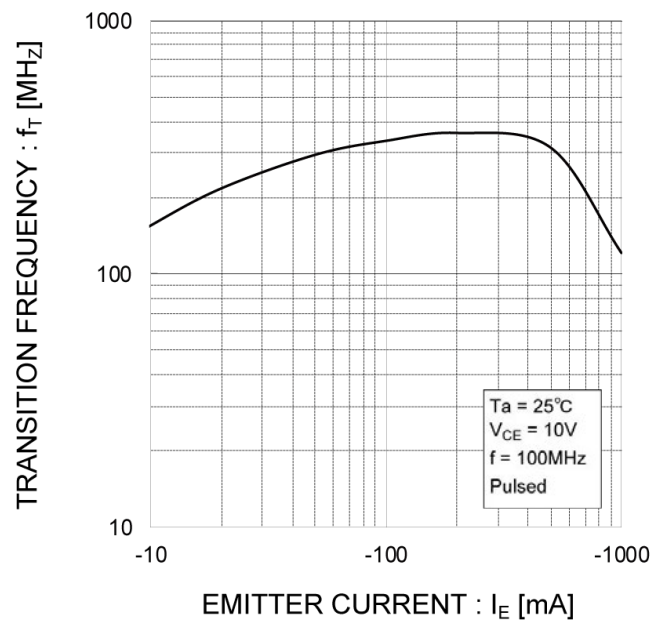


Fig.8 Gain bandwidth product vs. emitter



●Electrical characteristic curves($T_a=25^\circ\text{C}$) <For Tr1(NPN)>

Fig.9 Emitter input capacitance vs.
Emitter-base voltage
Collector output capacitance vs.
collector-base voltage

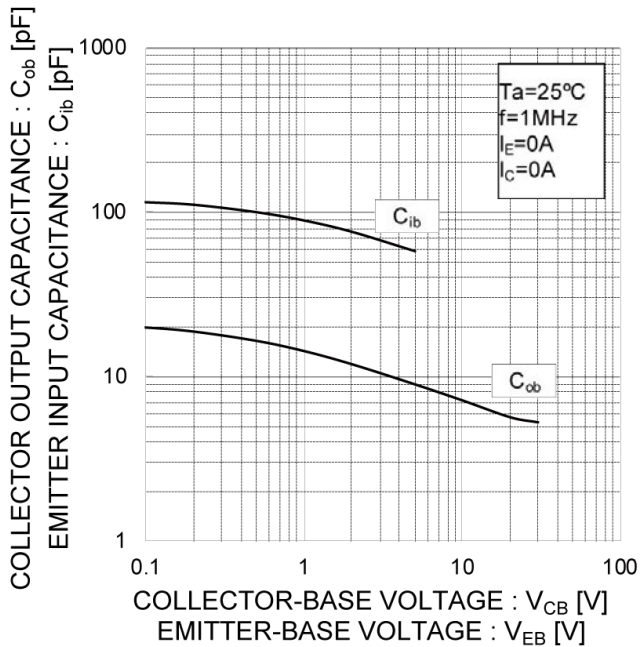
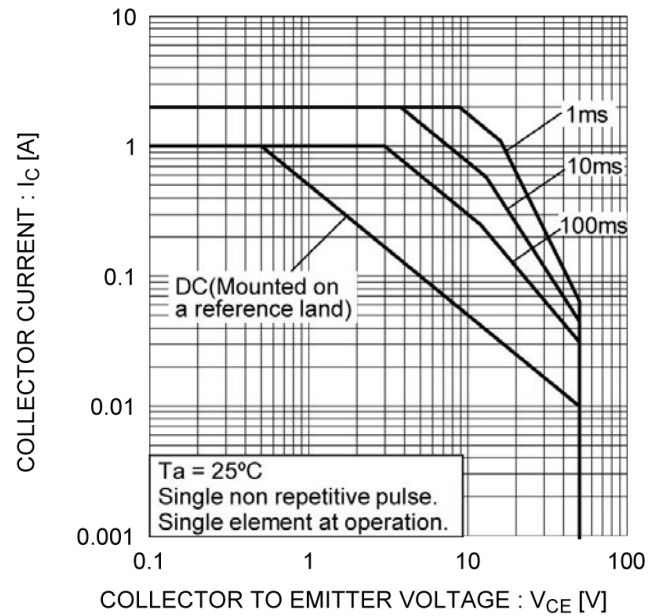
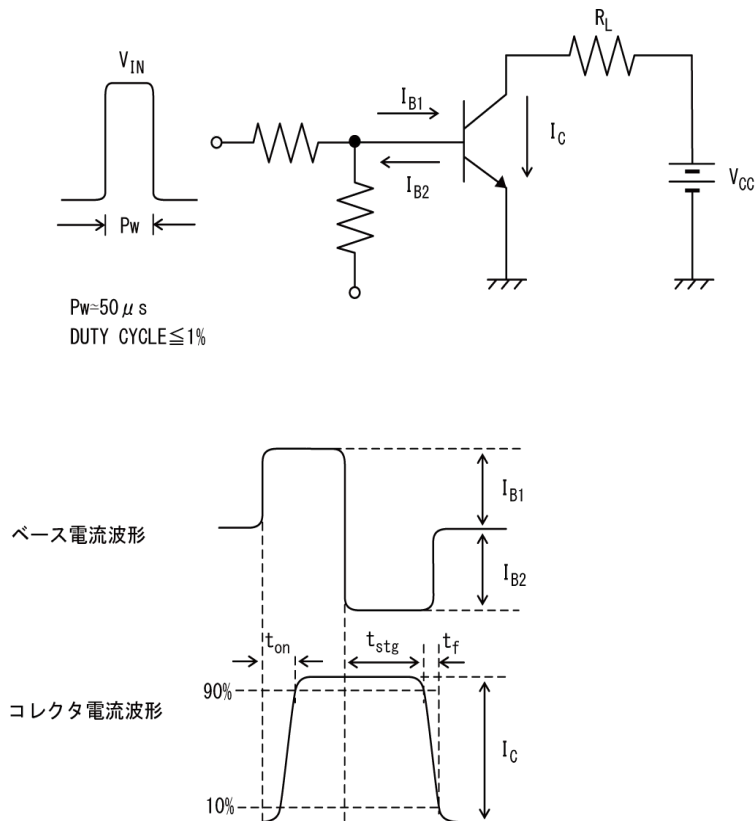


Fig.10 Safe Operation Area



●Switching time test circuit($T_a=25^\circ\text{C}$) <For Tr1(NPN)>



● Electrical characteristic curves ($T_a=25^\circ\text{C}$) <For Tr2(PNP)>

Fig.1 Ground emitter propagation characteristics

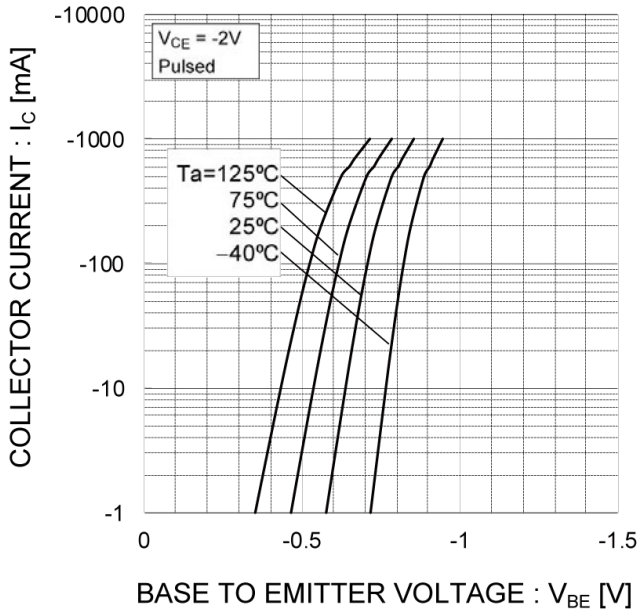


Fig.2 Typical output characteristics

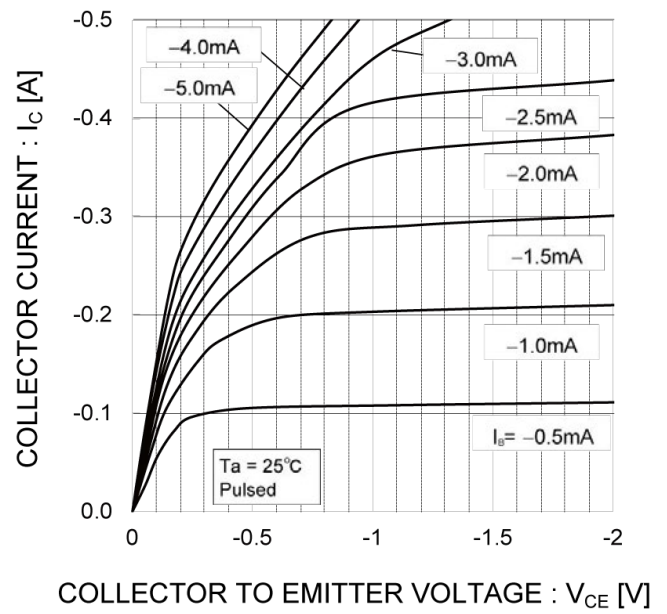


Fig.3 DC current gain vs. collector current (I)

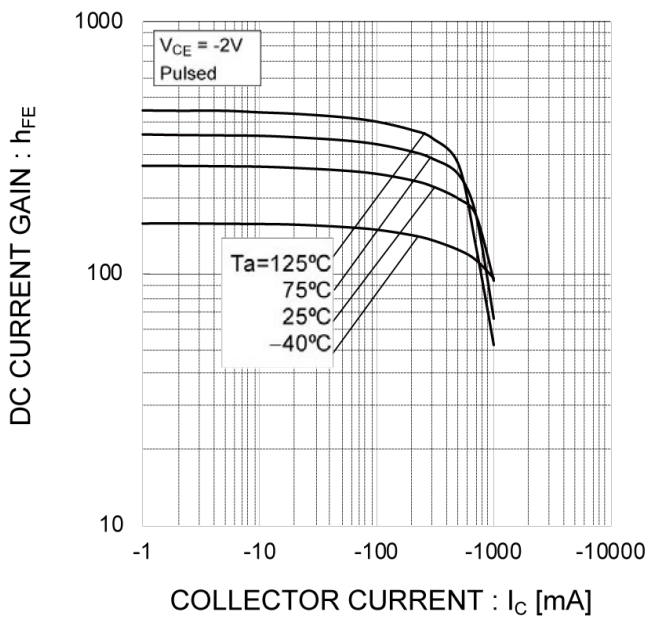
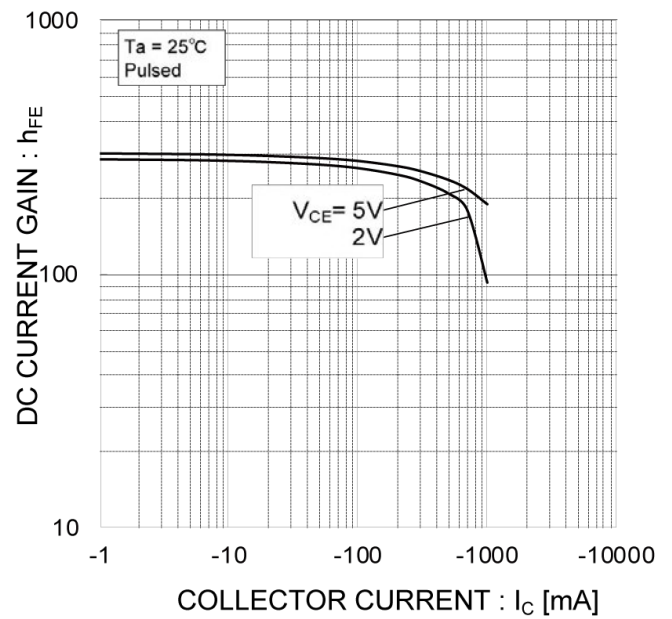


Fig.4 DC current gain vs. collector current (II)



● Electrical characteristic curves ($T_a = 25^\circ\text{C}$) <For Tr2(PNP)>

Fig.5 Collector-emitter saturation voltage vs. collector current (I)

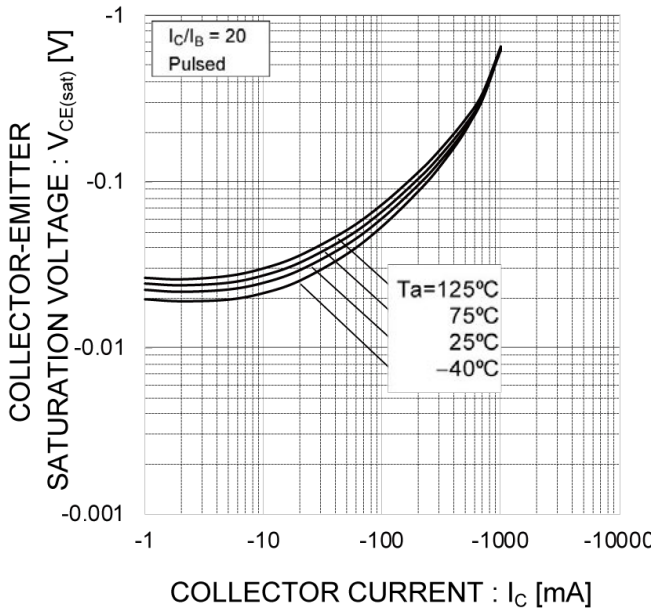


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

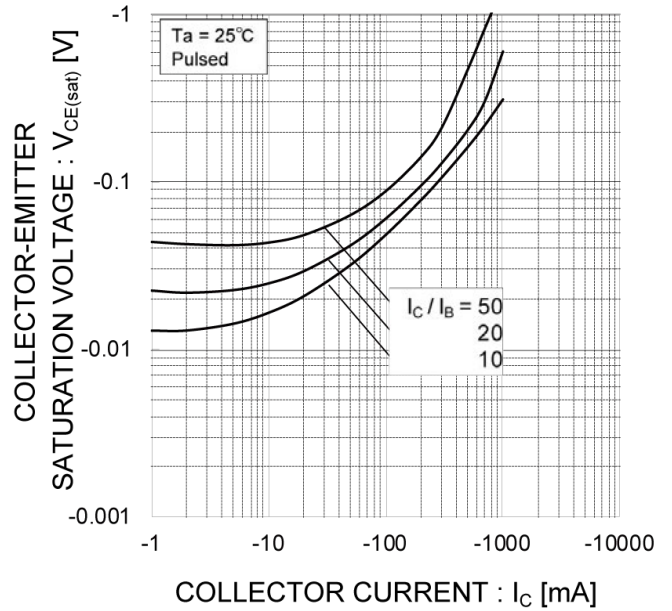


Fig.7 Base-emitter saturation voltage vs. collector current

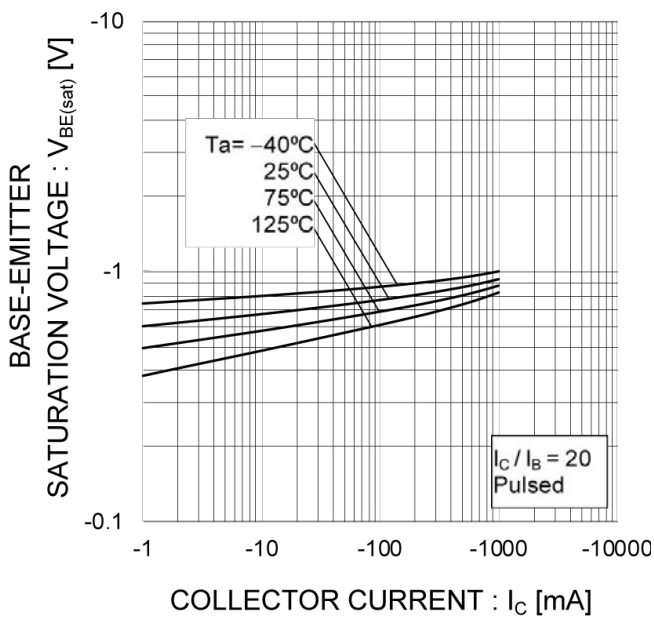
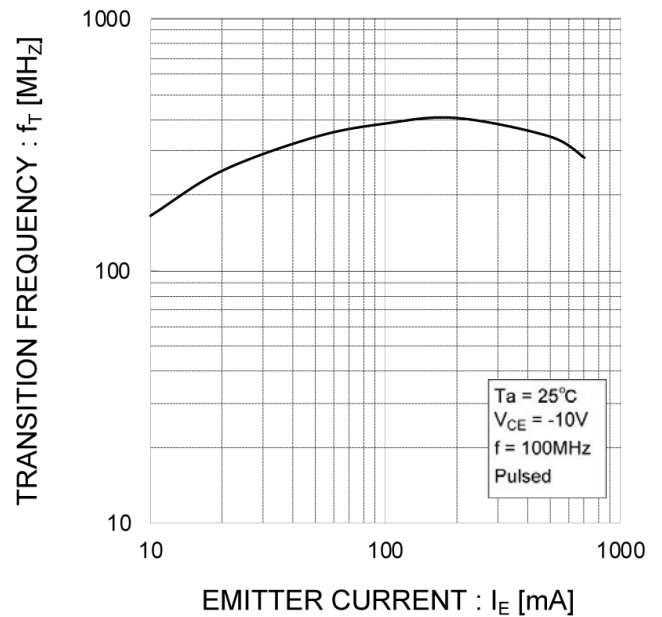


Fig.8 Gain bandwidth product vs. emitter



●Electrical characteristic curves($T_a=25^\circ\text{C}$) <For Tr2(PNP)>

Fig.9 Emitter input capacitance vs.
Emitter-base voltage
Collector output capacitance vs.
collector-base voltage

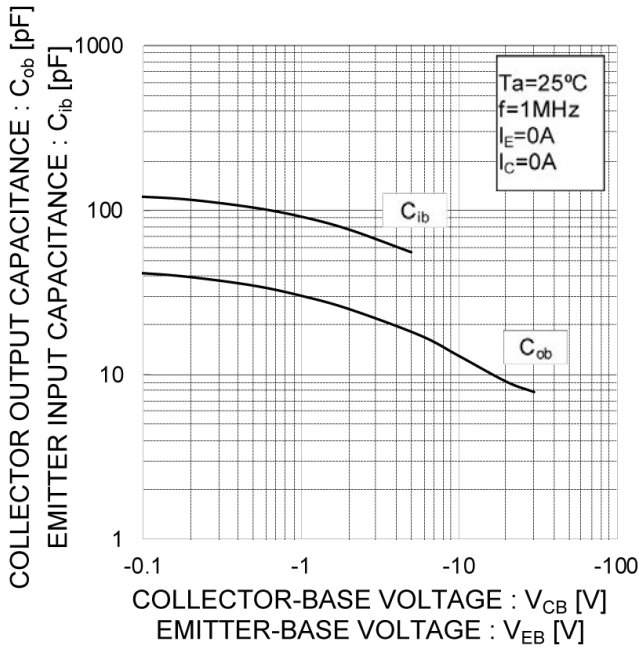
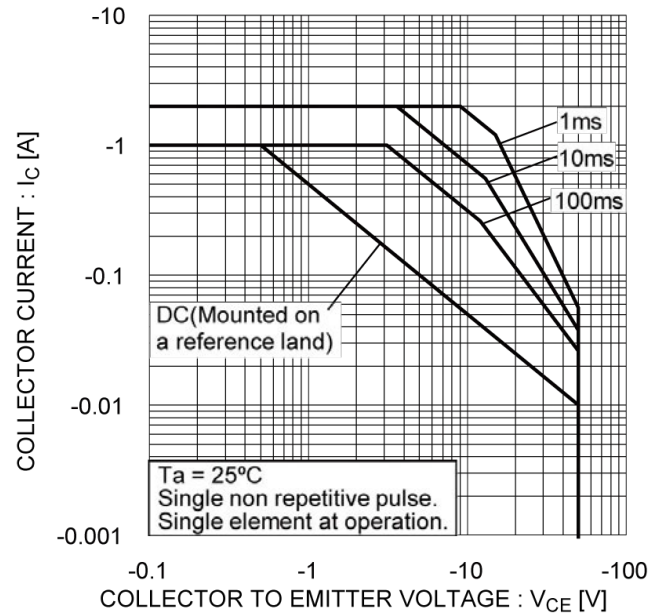
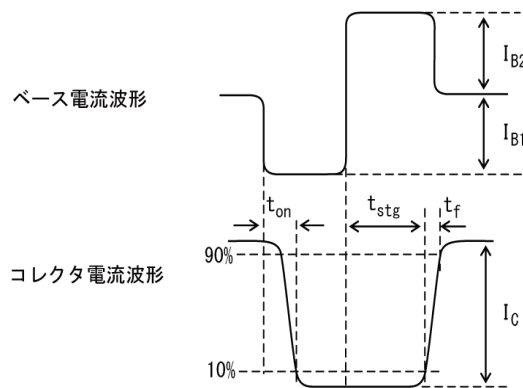
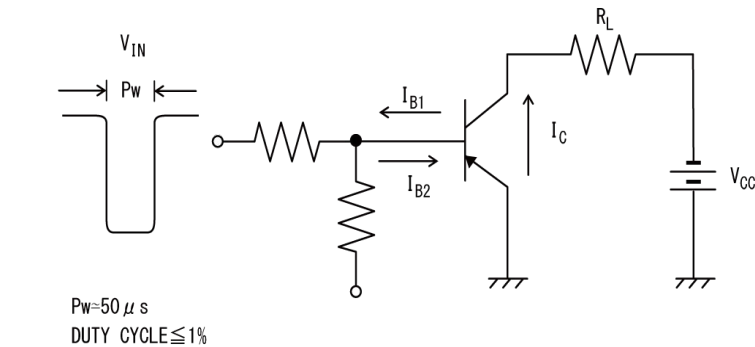


Fig.10 Safe Operation Area

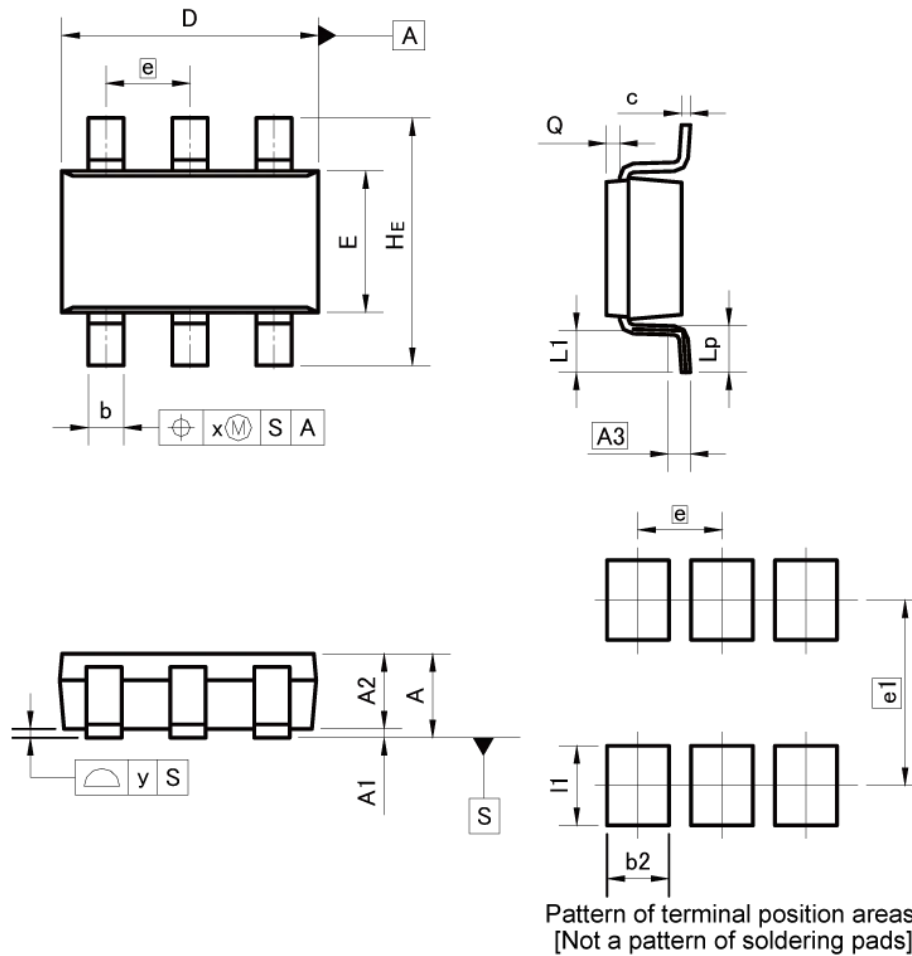


●Switching time test circuit($T_a=25^\circ\text{C}$) <For Tr2(PNP)>



●Dimensions

SOT-457T
SC-95
(TSMT6)



Pattern of terminal position areas
[Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	-	1.00	-	0.039
A1	0.00	0.10	0.000	0.004
A2	0.75	0.95	0.030	0.037
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
c	0.10	0.26	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
e	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.05	0.25	0.002	0.010
x	-	0.20	-	0.008
y	-	0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.70	-	0.028
e1	2.10		0.083	
I1	-	0.90	-	0.035

Dimension in mm/inches

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JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

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 - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.) ; or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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